Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	ARM® Cortex®-M4/M0
Core Size	32-Bit Dual-Core
Speed	204MHz
Connectivity	CANbus, EBI/EMI, Ethernet, I²C, IrDA, Microwire, SD, SPI, SSI, SSP, UART/USART, USB, USB OTG
Peripherals	Brown-out Detect/Reset, DMA, I²S, Motor Control PWM, POR, PWM, WDT
Number of I/O	83
Program Memory Size	-
Program Memory Type	ROMless
EEPROM Size	-
RAM Size	264K x 8
Voltage - Supply (Vcc/Vdd)	2.2V ~ 3.6V
Data Converters	A/D 8x10b; D/A 1x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	144-LQFP
Supplier Device Package	144-LQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/lpc4330fbd144-551

Table 3. Pin description *…continued*

LCD, Ethernet, USB0, and USB1 functions are not available on all parts. See Table 2.

Symbol	LBGA256	TFBGA180	TFBGA100	LQFP144		Reset state [1]	Type	Description
P1_16	M7	L5	H9	64	[2]	N; PU	I/O	**GPIO0[3] —** General purpose digital input/output pin.
							I	**U2_RXD —** Receiver input for USART2.
							I/O	**SGPIO3 —** General purpose digital input/output pin.
							I	**ENET_CRS —** Ethernet Carrier Sense (MII interface).
							O	**T0_MAT0 —** Match output 0 of timer 0.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							I	**ENET_RX_DV —** Ethernet Receive Data Valid (RMII/MII interface).
P1_17	M8	L6	H10	66	[3]	N; PU	I/O	**GPIO0[12] —** General purpose digital input/output pin.
							I/O	**U2_UCLK —** Serial clock input/output for USART2 in synchronous mode.
							-	**R —** Function reserved.
							I/O	**ENET_MDIO —** Ethernet MIIM data input and output.
							I	**T0_CAP3 —** Capture input 3 of timer 0.
							O	**CAN1_TD —** CAN1 transmitter output.
							I/O	**SGPIO11 —** General purpose digital input/output pin.
							-	**R —** Function reserved.
P1_18	N12	N10	J10	67	[2]	N; PU	I/O	**GPIO0[13] —** General purpose digital input/output pin.
							I/O	**U2_DIR —** RS-485/EIA-485 output enable/direction control for USART2.
							-	**R —** Function reserved.
							O	**ENET_TXD0 —** Ethernet transmit data 0 (RMII/MII interface).
							O	**T0_MAT3 —** Match output 3 of timer 0.
							I	**CAN1_RD —** CAN1 receiver input.
							I/O	**SGPIO12 —** General purpose digital input/output pin.
							-	**R —** Function reserved.
P1_19	M11	N9	K9	68	[2]	N; PU	I	**ENET_TX_CLK (ENET_REF_CLK) —** Ethernet Transmit Clock (MII interface) or Ethernet Reference Clock (RMII interface).
							I/O	**SSP1_SCK —** Serial clock for SSP1.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							O	**CLKOUT —** Clock output pin.
							-	**R —** Function reserved.
							O	**I2S0_RX_MCLK —** I2S receive master clock.
							I/O	**I2S1_TX_SCK —** Transmit Clock. It is driven by the master and received by the slave. Corresponds to the signal SCK in the I^2S-bus specification.

Table 3. Pin description *…continued*

LCD, Ethernet, USB0, and USB1 functions are not available on all parts. See Table 2.

Symbol	LBGA256	TFBGA180	TFBGA100	LQFP144		Reset state [1]	Type	Description
P5_6	T13	M11	-	63	[2]	N; PU	I/O	**GPIO2[15] —** General purpose digital input/output pin.
							O	**MCOB1 —** Motor control PWM channel 1, output B.
							I/O	**EMC_D10 —** External memory data line 10.
							-	**R —** Function reserved.
							O	**U1_TXD —** Transmitter output for UART 1.
							O	**T1_MAT2 —** Match output 2 of timer 1.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
P5_7	R12	N11	-	65	[2]	N; PU	I/O	**GPIO2[7] —** General purpose digital input/output pin.
							O	**MCOA2 —** Motor control PWM channel 2, output A.
							I/O	**EMC_D11 —** External memory data line 11.
							-	**R —** Function reserved.
							I	**U1_RXD —** Receiver input for UART 1.
							O	**T1_MAT3 —** Match output 3 of timer 1.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
P6_0	M12	M10	H7	73	[2]	N; PU	-	**R —** Function reserved.
							O	**I2S0_RX_MCLK —** I2S receive master clock.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							I/O	**I2S0_RX_SCK —** Receive Clock. It is driven by the master and received by the slave. Corresponds to the signal SCK in the *I^2S-bus specification*.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
P6_1	R15	P14	G5	74	[2]	N; PU	I/O	**GPIO3[0] —** General purpose digital input/output pin.
							O	**EMC_DYCS1 —** SDRAM chip select 1.
							I/O	**U0_UCLK —** Serial clock input/output for USART0 in synchronous mode.
							I/O	**I2S0_RX_WS —** Receive Word Select. It is driven by the master and received by the slave. Corresponds to the signal WS in the *I^2S-bus specification*.
							-	**R —** Function reserved.
							I	**T2_CAP0 —** Capture input 2 of timer 2.
							-	**R —** Function reserved.
							-	**R —** Function reserved.

Table 3. Pin description *…continued*

LCD, Ethernet, USB0, and USB1 functions are not available on all parts. See Table 2.

Symbol	LBGA256	TFBGA180	TFBGA100	LQFP144		Reset state [1]	Type	Description
PC_11	L5	-	-	-	[2]	N; PU	-	**R —** Function reserved.
							I	**USB1_ULPI_DIR —** ULPI link DIR signal. Controls the ULPI data line direction.
							I	**U1_DCD —** Data Carrier Detect input for UART 1.
							-	**R —** Function reserved.
							I/O	**GPIO6[10] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							I/O	**SD_DAT4 —** SD/MMC data bus line 4.
PC_12	L6	-	-	-	[2]	N; PU	-	**R —** Function reserved.
							-	**R —** Function reserved.
							O	**U1_DTR —** Data Terminal Ready output for UART 1. Can also be configured to be an RS-485/EIA-485 output enable signal for UART 1.
							-	**R —** Function reserved.
							I/O	**GPIO6[11] —** General purpose digital input/output pin.
							I/O	**SGPIO11 —** General purpose digital input/output pin.
							I/O	**I2S0_TX_SDA —** I2S transmit data. It is driven by the transmitter and read by the receiver. Corresponds to the signal SD in the *I^2S-bus specification*.
							I/O	**SD_DAT5 —** SD/MMC data bus line 5.
PC_13	M1	-	-	-	[2]	N; PU	-	**R —** Function reserved.
							-	**R —** Function reserved.
							O	**U1_TXD —** Transmitter output for UART 1.
							-	**R —** Function reserved.
							I/O	**GPIO6[12] —** General purpose digital input/output pin.
							I/O	**SGPIO12 —** General purpose digital input/output pin.
							I/O	**I2S0_TX_WS —** Transmit Word Select. It is driven by the master and received by the slave. Corresponds to the signal WS in the *I^2S-bus specification*.
							I/O	**SD_DAT6 —** SD/MMC data bus line 6.
PC_14	N1	-	-	-	[2]	N; PU	-	**R —** Function reserved.
							-	**R —** Function reserved.
							I	**U1_RXD —** Receiver input for UART 1.
							-	**R —** Function reserved.
							I/O	**GPIO6[13] —** General purpose digital input/output pin.
							I/O	**SGPIO13 —** General purpose digital input/output pin.
							O	**ENET_TX_ER —** Ethernet Transmit Error (MII interface).
							I/O	**SD_DAT7 —** SD/MMC data bus line 7.

Table 3. Pin description *…continued*

LCD, Ethernet, USB0, and USB1 functions are not available on all parts. See Table 2.

Symbol	LBGA256	TFBGA180	TFBGA100	LQFP144		Reset state [1]	Type	Description
PD_4	T2	-	-	-	[2]	N; PU	-	**R —** Function reserved.
							O	**CTOUT_8 —** SCTimer/PWM output 8. Match output 0 of timer 2.
							I/O	**EMC_D18 —** External memory data line 18.
							-	**R —** Function reserved.
							I/O	**GPIO6[18] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							I/O	**SGPIO8 —** General purpose digital input/output pin.
PD_5	P6	-	-	-	[2]	N; PU	-	**R —** Function reserved.
							O	**CTOUT_9 —** SCTimer/PWM output 9. Match output 3 of timer 3.
							I/O	**EMC_D19 —** External memory data line 19.
							-	**R —** Function reserved.
							I/O	**GPIO6[19] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							I/O	**SGPIO9 —** General purpose digital input/output pin.
PD_6	R6	-	-	-	[2]	N; PU	-	**R —** Function reserved.
							O	**CTOUT_10 —** SCTimer/PWM output 10. Match output 3 of timer 3.
							I/O	**EMC_D20 —** External memory data line 20.
							-	**R —** Function reserved.
							I/O	**GPIO6[20] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							I/O	**SGPIO10 —** General purpose digital input/output pin.
PD_7	T6	-	-	-	[2]	N; PU	-	**R —** Function reserved.
							I	**CTIN_5 —** SCTimer/PWM input 5. Capture input 2 of timer 2.
							I/O	**EMC_D21 —** External memory data line 21.
							-	**R —** Function reserved.
							I/O	**GPIO6[21] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							I/O	**SGPIO11 —** General purpose digital input/output pin.

Table 3. Pin description *…continued*

LCD, Ethernet, USB0, and USB1 functions are not available on all parts. See Table 2.

Symbol	LBGA256	TFBGA180	TFBGA100	LQFP144		Reset state [1]	Type	Description
PE_15	E13	-	-	-	[2]	N; PU	-	**R —** Function reserved.
							O	**CTOUT_0 —** SCTimer/PWM output 0. Match output 0 of timer 0.
							I/O	**I2C1_SCL —** I^2C1 clock input/output (this pin does not use a specialized I2C pad).
							O	**EMC_CKEOUT3 —** SDRAM clock enable 3.
							I/O	**GPIO7[15] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
PF_0	D12	-	-	-	[2]	O; PU	I/O	**SSP0_SCK —** Serial clock for SSP0.
							I	**GP_CLKIN —** General-purpose clock input to the CGU.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							O	**I2S1_TX_MCLK —** I2S1 transmit master clock.
PF_1	E11	-	-	-	[2]	N; PU	-	**R —** Function reserved.
							-	**R —** Function reserved.
							I/O	**SSP0_SSEL —** Slave Select for SSP0.
							-	**R —** Function reserved.
							I/O	**GPIO7[16] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							I/O	**SGPIO0 —** General purpose digital input/output pin.
							-	**R —** Function reserved.
PF_2	D11	-	-	-	[2]	N; PU	-	**R —** Function reserved.
							O	**U3_TXD —** Transmitter output for USART3.
							I/O	**SSP0_MISO —** Master In Slave Out for SSP0.
							-	**R —** Function reserved.
							I/O	**GPIO7[17] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							I/O	**SGPIO1 —** General purpose digital input/output pin.
							-	**R —** Function reserved.

7.14 One-Time Programmable (OTP) memory

The OTP provides 64 bit + 256 bit One-Time Programmable (OTP) memory for general-purpose use.

7.15 General-Purpose I/O (GPIO)

The LPC4350/30/20/10 provide eight GPIO ports with up to 31 GPIO pins each.

Device pins that are not connected to a specific peripheral function are controlled by the GPIO registers. Pins may be dynamically configured as inputs or outputs. Separate registers allow setting or clearing any number of outputs simultaneously. The value of the output register may be read back as well as the current state of the port pins.

All GPIO pins default to inputs with pull-up resistors enabled and input buffer disabled on reset. The input buffer must be turned on in the system control block SFS register before the GPIO input can be read.

7.15.1 Features

- Accelerated GPIO functions:
  - GPIO registers are located on the AHB so that the fastest possible I/O timing can be achieved.
  - Mask registers allow treating sets of port bits as a group, leaving other bits unchanged.
  - All GPIO registers are byte and half-word addressable.
  - Entire port value can be written in one instruction.
- Bit-level set and clear registers allow a single instruction set or clear of any number of bits in one port.
- Direction control of individual bits.
- Up to eight GPIO pins can be selected from all GPIO pins to create an edge- or level-sensitive GPIO interrupt request (GPIO interrupts).
- Two GPIO group interrupts can be triggered by any pin or pins in each port (GPIO group0 and group1 interrupts).

7.16 Configurable digital peripherals

7.16.1 State Configurable Timer (SCTimer/PWM) subsystem

The SCTimer/PWM allows a wide variety of timing, counting, output modulation, and input capture operations. The inputs and outputs of the SCTimer/PWM are shared with the capture and match inputs/outputs of the 32-bit general-purpose counter/timers.

The SCTimer/PWM can be configured as two 16-bit counters or a unified 32-bit counter. In the two-counter case, in addition to the counter value the following operational elements are independent for each half:

- State variable
- Limit, halt, stop, and start conditions
- Values of Match/Capture registers, plus reload or capture control values

- LCD panel clock may be generated from the peripheral clock, or from a clock input pin.

7.17.8 Ethernet

Remark: The Ethernet peripheral is available on parts LPC4350/30. See Table 2.

7.17.8.1 Features

- 10/100 Mbit/s.
- DMA support.
- Power management remote wake-up frame and magic packet detection.
- Supports both full-duplex and half-duplex operation
  - Supports CSMA/CD Protocol for half-duplex operation.
  - Supports IEEE 802.3x flow control for full-duplex operation.
  - Optional forwarding of received pause control frames to the user application in full-duplex operation.
  - Back-pressure support for half-duplex operation.
  - Automatic transmission of zero-quanta pause frame on deassertion of flow control input in full-duplex operation.
- Supports IEEE1588 time stamping and IEEE 1588 advanced time stamping (IEEE 1588-2008 v2).

7.18 Digital serial peripherals

7.18.1 UART1

The LPC4350/30/20/10 contain one UART with standard transmit and receive data lines. UART1 also provides a full modem control handshake interface and support for RS-485/9-bit mode allowing both software address detection and automatic address detection using 9-bit mode.

UART1 includes a fractional baud rate generator. Standard baud rates such as 115200 Bd can be achieved with any crystal frequency above 2 MHz.

7.18.1.1 Features

- Maximum UART data bit rate of 8 MBit/s.
- 16 B Receive and Transmit FIFOs.
- Register locations conform to 16C550 industry standard.
- Receiver FIFO trigger points at 1 B, 4 B, 8 B, and 14 B.
- Built-in fractional baud rate generator covering wide range of baud rates without a need for external crystals of particular values.
- Auto baud capabilities and FIFO control mechanism that enables software flow control implementation.
- Equipped with standard modem interface signals. This module also provides full support for hardware flow control.
- Support for RS-485/9-bit/EIA-485 mode (UART1).

- DMA support.

7.18.2 USART0/2/3

The LPC4350/30/20/10 contain three USARTs. In addition to standard transmit and receive data lines, the USARTs support a synchronous mode.

The USARTs include a fractional baud rate generator. Standard baud rates such as 115200 Bd can be achieved with any crystal frequency above 2 MHz.

7.18.2.1 Features

- Maximum UART data bit rate of 8 MBit/s.
- 16 B Receive and Transmit FIFOs.
- Register locations conform to 16C550 industry standard.
- Receiver FIFO trigger points at 1 B, 4 B, 8 B, and 14 B.
- Built-in fractional baud rate generator covering wide range of baud rates without a need for external crystals of particular values.
- Auto baud capabilities and FIFO control mechanism that enables software flow control implementation.
- Support for RS-485/9-bit/EIA-485 mode.
- USART3 includes an IrDA mode to support infrared communication.
- All USARTs have DMA support.
- Support for synchronous mode at a data bit rate of up to 8 Mbit/s.
- Smart card mode conforming to ISO7816 specification

7.18.3 SPI serial I/O controller

The LPC4350/30/20/10 contain one SPI controller. SPI is a full-duplex serial interface designed to handle multiple masters and slaves connected to a given bus. Only a single master and a single slave can communicate on the interface during a given data transfer. During a data transfer the master always sends 8 bits to 16 bits of data to the slave, and the slave always sends 8 bits to 16 bits of data to the master.

7.18.3.1 Features

- Maximum SPI data bit rate 25 Mbit/s.
- Compliant with SPI specification.
- Synchronous, serial, full-duplex communication.
- Combined SPI master and slave.
- Maximum data bit rate of one eighth of the input clock rate.
- 8 bits to 16 bits per transfer.

7.18.4 SSP serial I/O controller

Remark: The LPC4350/30/20/10 contain two SSP controllers.

The SSP controller can operate on a SPI, 4-wire SSI, or Microwire bus. It can interact with multiple masters and slaves on the bus. Only a single master and a single slave can communicate on the bus during a given data transfer. The SSP supports full-duplex

The I²S-bus provides a standard communication interface for digital audio applications.

The *I²S-bus specification* defines a 3-wire serial bus using one data line, one clock line, and one word select signal. The basic I²S-bus connection has one master, which is always the master, and one slave. The I²S-bus interface provides a separate transmit and receive channel, each of which can operate as either a master or a slave.

7.18.6.1 Features

- The I²S interface has separate input/output channels, each of which can operate in master or slave mode.
- Capable of handling 8-bit, 16-bit, and 32-bit word sizes.
- Mono and stereo audio data supported.
- The sampling frequency can range from 16 kHz to 192 kHz (16, 22.05, 32, 44.1, 48, 96, 192) kHz.
- Support for an audio master clock.
- Configurable word select period in master mode (separately for I²S-bus input and output).
- Two 8-word FIFO data buffers are provided, one for transmit and one for receive.
- Generates interrupt requests when buffer levels cross a programmable boundary.
- Two DMA requests controlled by programmable buffer levels. The DMA requests are connected to the GPDMA block.
- Controls include reset, stop and mute options separately for I²S-bus input and I²S-bus output.

7.18.7 C_CAN

Remark: The LPC4350/30/20/10 contain two C_CAN controllers.

Controller Area Network (CAN) is the definition of a high performance communication protocol for serial data communication. The C_CAN controller is designed to provide a full implementation of the CAN protocol according to the CAN Specification Version 2.0B. The C_CAN controller can create powerful local networks with low-cost multiplex wiring by supporting distributed real-time control with a high level of reliability.

7.18.7.1 Features

- Conforms to protocol version 2.0 parts A and B.
- Supports bit rate of up to 1 Mbit/s.
- Supports 32 Message Objects.
- Each Message Object has its own identifier mask.
- Provides programmable FIFO mode (concatenation of Message Objects).
- Provides maskable interrupts.
- Supports Disabled Automatic Retransmission (DAR) mode for time-triggered CAN applications.
- Provides programmable loop-back mode for self-test operation.

10. Static characteristics

Table 10. Static characteristics

T_{amb} = −40 °C to +85 °C, unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ[1]	Max	Unit
Supply pins							
$V_{DD(IO)}$	input/output supply voltage			2.2	-	3.6	V
$V_{DD(REG)(3V3)}$	regulator supply voltage (3.3 V)		[2]	2.2	-	3.6	V
$V_{DDA(3V3)}$	analog supply voltage (3.3 V)	on pin VDDA		2.2	-	3.6	V
		on pins USB0_VDDA3V3_ DRIVER and USB0_VDDA3V3		3.0	3.3	3.6	V
V_{BAT}	battery supply voltage		[2]	2.2	-	3.6	V
$V_{prog(pf)}$	polyfuse programming voltage	on pin VPP (for OTP)	[3]	2.7	-	3.6	V
$I_{prog(pf)}$	polyfuse programming current	on pin VPP; OTP programming time ≤ 1.6 ms		-	-	30	mA
$I_{DD(REG)(3V3)}$	regulator supply current (3.3 V)	Active mode; M0-core in reset; code `while(1){}` executed from RAM; all peripherals disabled; PLL1 enabled					
		CCLK = 12 MHz	[4]	-	6.6	-	mA
		CCLK = 60 MHz	[4]		25.3	-	mA
		CCLK = 120 MHz	[4]	-	48.4	-	mA
		CCLK = 180 MHz	[4]	-	72.0	-	mA
		CCLK = 204 MHz	[4]	-	81.5	-	mA
$I_{DD(REG)(3V3)}$	regulator supply current (3.3 V)	after WFE/WFI instruction executed from RAM; all peripherals disabled; M0 core in reset					
		sleep mode	[4][5]	-	5.0	-	mA
		deep-sleep mode	[4]	-	30	-	μA
		power-down mode	[4]	-	15	-	μA
		deep power-down mode	[4][6]	-	0.03	-	μA
		deep power-down mode; VBAT floating	[4]	-	2	-	μA
I_{BAT}	battery supply current	active mode; V_{BAT} = 3.2 V; $V_{DD(REG)(3V3)}$ = 3.6 V.	[7]	-	0	-	nA

Table 10. Static characteristics *…continued*
T_{amb} = −40 °C to +85 °C, unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ[1]	Max	Unit
Oscillator pins							
$V_{i(XTAL1)}$	input voltage on pin XTAL1			−0.5	-	1.2	V
$V_{o(XTAL2)}$	output voltage on pin XTAL2			−0.5	-	1.2	V
C_{io}	input/output capacitance		[17]	-	-	0.8	pF
USB0 pins[18]							
V_I	input voltage	on pins USB0_DP; USB0_DM; USB0_VBUS					
		$V_{DD(IO)} \geq 2.2$ V		0	-	5.25	V
		$V_{DD(IO)}$ = 0 V		0	-	3.6	V
R_{pd}	pull-down resistance	on pin USB0_VBUS		48	64	80	kΩ
V_{IC}	common-mode input voltage	high-speed mode		−50	200	500	mV
		full-speed/low-speed mode		800	-	2500	mV
		chirp mode		−50	-	600	mV
$V_{i(dif)}$	differential input voltage			100	400	1100	mV
USB1 pins (USB1_DP/USB1_DM)[18]							
I_{OZ}	OFF-state output current	0 V < V_I < 3.3 V	[18]	-	-	±10	μA
V_{BUS}	bus supply voltage		[19]	-	-	5.25	V
V_{DI}	differential input sensitivity voltage	|(D+) − (D−)|		0.2	-	-	V
V_{CM}	differential common mode voltage range	includes V_{DI} range		0.8	-	2.5	V
$V_{th(rs)se}$	single-ended receiver switching threshold voltage			0.8	-	2.0	V
V_{OL}	LOW-level output voltage for low-/full-speed	R_L of 1.5 kΩ to 3.6 V		-	-	0.18	V
V_{OH}	HIGH-level output voltage (driven) for low-/full-speed	R_L of 15 kΩ to GND		2.8	-	3.5	V
C_{trans}	transceiver capacitance	pin to GND		-	-	20	pF
Z_{DRV}	driver output impedance for driver which is not high-speed capable	with 33 Ω series resistor; steady state drive	[20]	36	-	44.1	Ω

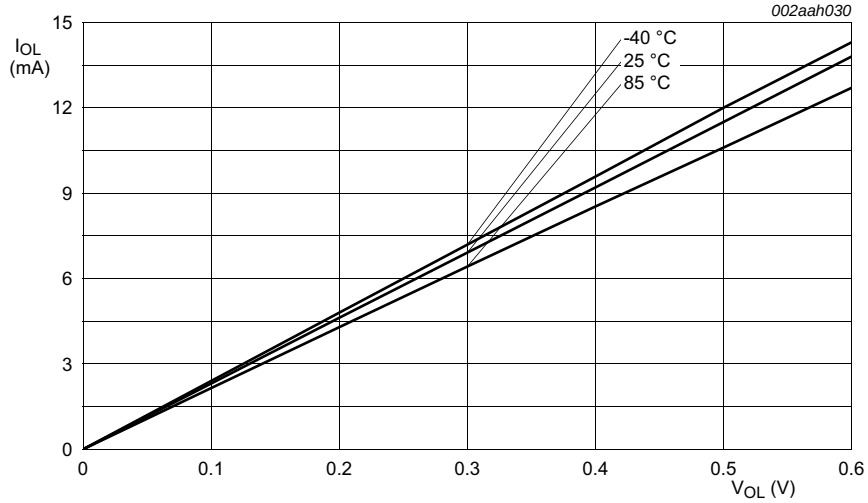
[1] Typical ratings are not guaranteed. The values listed are at room temperature (25 °C), nominal supply voltages.

[2] The recommended operating condition for the battery supply is $V_{DD(REG)(3V3)} > V_{BAT} + 0.2$ V. See Figure 18.

[3] Pin VPP should either be not connected (when OTP does not need to be programmed) or tied to pins VDDIO and VDDREG to ensure the same ramp-up time for both supply voltages.

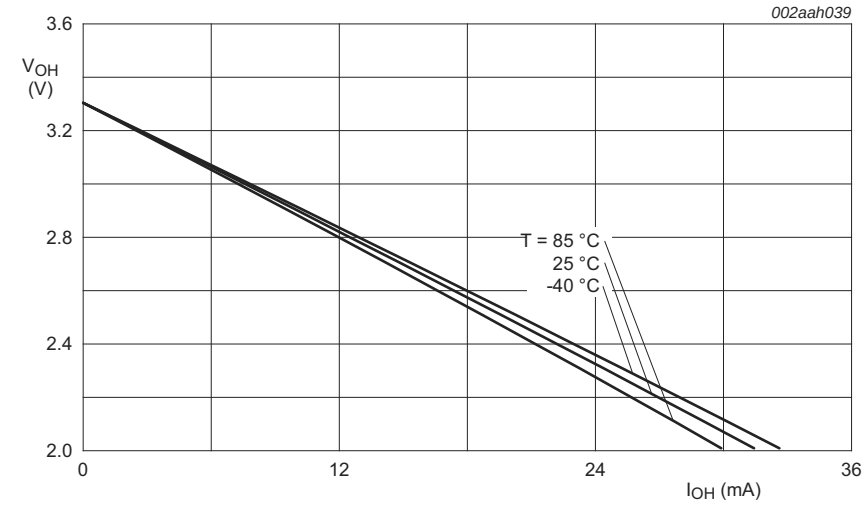
[4] $V_{DD(REG)(3V3)}$ = 3.3 V; $V_{DD(IO)}$ = 3.3 V; T_{amb} = 25 °C.

10.4 Electrical pin characteristics



Conditions: $V_{DD(REG)(3V3)} = V_{DD(IO)} = 3.3$ V.

Fig 20. Normal-drive pins; typical LOW level output current I_{OL} versus LOW level output voltage V_{OL}



Conditions: $V_{DD(REG)(3V3)} = V_{DD(IO)} = 3.3$ V.

Fig 21. Normal-drive pins; typical HIGH level output voltage V_{OL} versus HGH level output current I_{OH}

11.16 USB interface

Table 30. Dynamic characteristics: USB0 and USB1 pins (full-speed)
C_L = 50 pF; R_{pu} = 1.5 kΩ on D+ to $V_{DD(IO)}$; 3.0 V ≤ $V_{DD(IO)}$ ≤ 3.6 V.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
t_r	rise time	10 % to 90 %		4	-	20	ns
t_f	fall time	10 % to 90 %		4	-	20	ns
t_{FRFM}	differential rise and fall time matching	t_r / t_f		90	-	111.11	%
V_{CRS}	output signal crossover voltage			1.3	-	2.0	V
t_{FEOPT}	source SE0 interval of EOP	see Figure 37		160	-	175	ns
t_{FDEOP}	source jitter for differential transition to SE0 transition	see Figure 37		−2	-	+5	ns
t_{JR1}	receiver jitter to next transition			−18.5	-	+18.5	ns
t_{JR2}	receiver jitter for paired transitions	10 % to 90 %		−9	-	+9	ns
t_{EOPR1}	EOP width at receiver	must reject as EOP; see Figure 37	[1]	40	-	-	ns
t_{EOPR2}	EOP width at receiver	must accept as EOP; see Figure 37	[1]	82	-	-	ns

[1] Characterized but not implemented as production test. Guaranteed by design.

Remark: If only USB0 (HS USB) is used, the pins VDDREG and VDDIO can be at different voltages within the operating range but should have the same ramp up time. If USB1(FS USB) is used, the pins VDDREG and VDDIO should be a minimum of 3.0 V and be tied together.

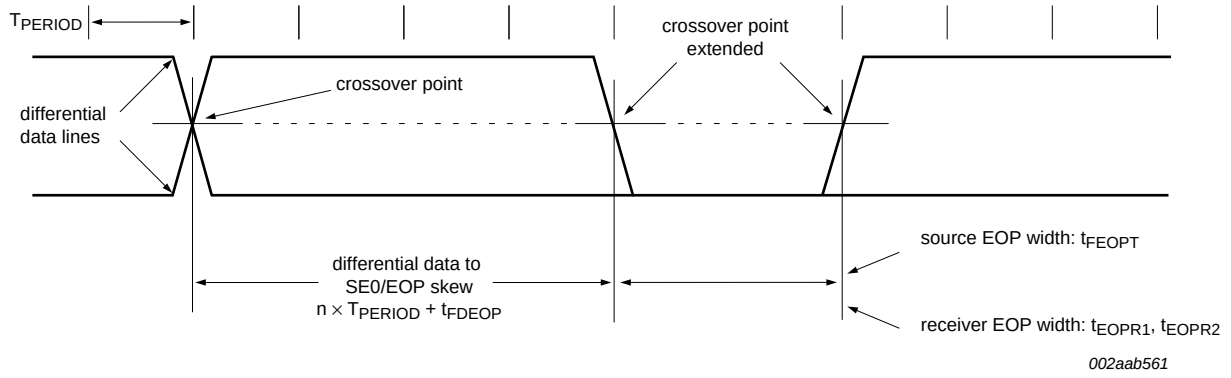
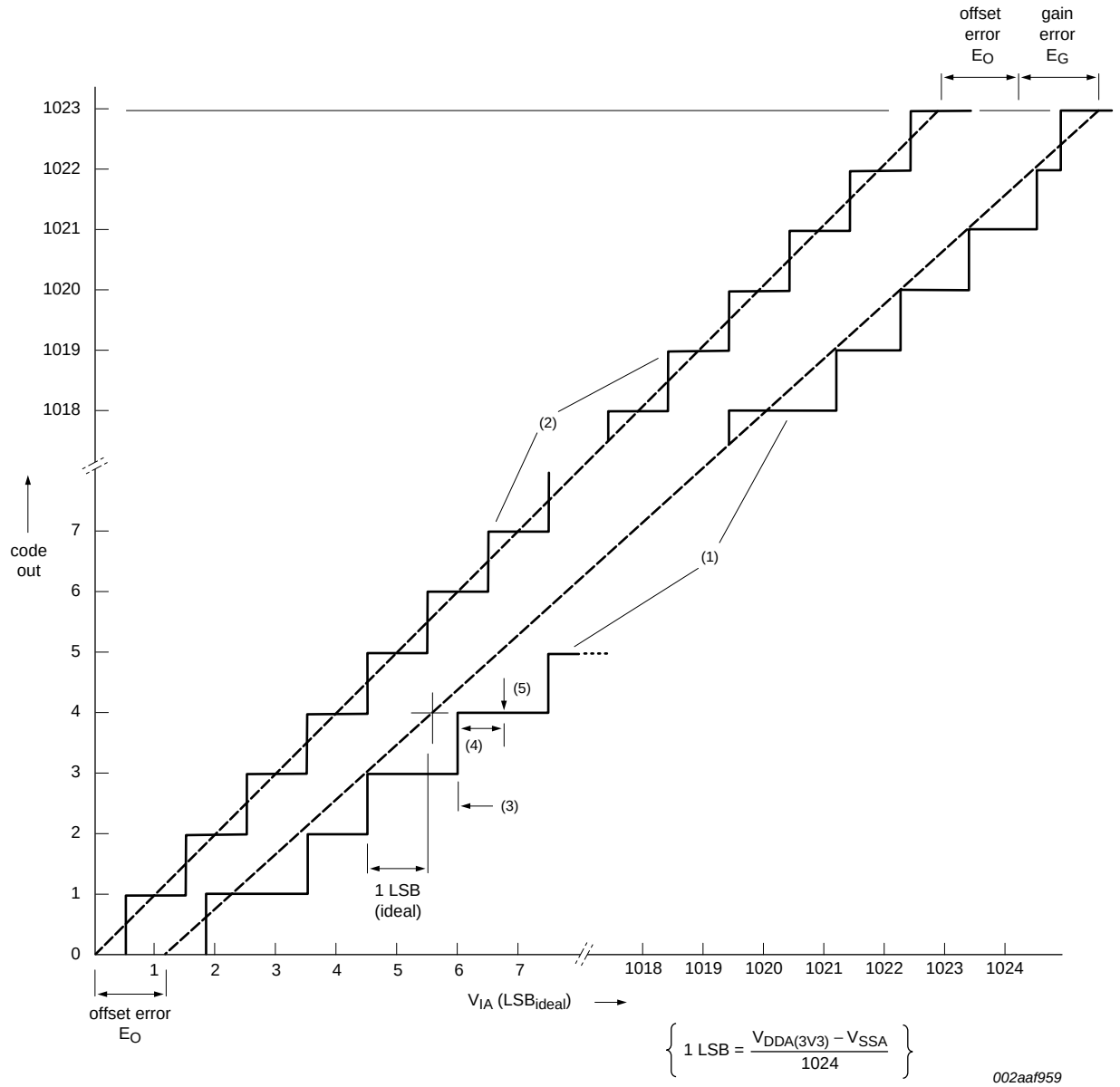


Fig 37. Differential data-to-EOP transition skew and EOP width



(1) Example of an actual transfer curve.

(2) The ideal transfer curve.

(3) Differential linearity error (E_D).

(4) Integral non-linearity ($E_{L(adj)}$).

(5) Center of a step of the actual transfer curve.

Fig 41. 10-bit ADC characteristics

13. Application information

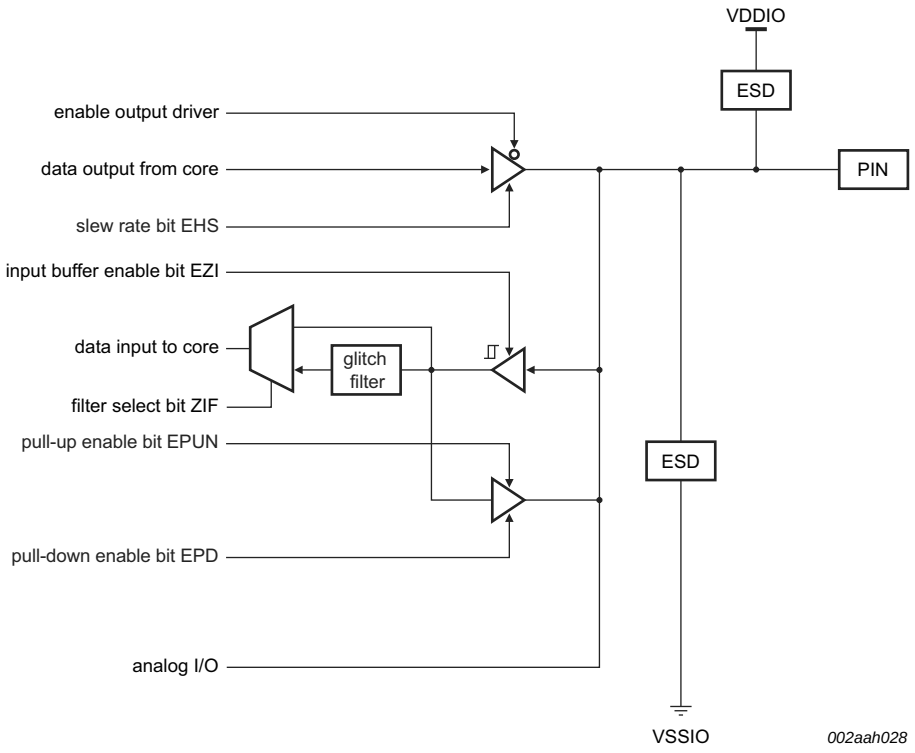
13.1 LCD panel signal usage

Table 38. LCD panel connections for STN single panel mode

External pin	4-bit mono STN single panel		8-bit mono STN single panel		Color STN single panel	
	LPC43xx pin used	LCD function	LPC43xx pin used	LCD function	LPC43xx pin used	LCD function
LCD_VD[23:8]	-	-	-	-	-	-
LCD_VD7	-	-	P8_4	UD[7]	P8_4	UD[7]
LCD_VD6	-	-	P8_5	UD[6]	P8_5	UD[6]
LCD_VD5	-	-	P8_6	UD[5]	P8_6	UD[5]
LCD_VD4	-	-	P8_7	UD[4]	P8_7	UD[4]
LCD_VD3	P4_2	UD[3]	P4_2	UD[3]	P4_2	UD[3]
LCD_VD2	P4_3	UD[2]	P4_3	UD[2]	P4_3	UD[2]
LCD_VD1	P4_4	UD[1]	P4_4	UD[1]	P4_4	UD[1]
LCD_VD0	P4_1	UD[0]	P4_1	UD[0]	P4_1	UD[0]
LCD_LP	P7_6	LCDLP	P7_6	LCDLP	P7_6	LCDLP
LCD_ENAB/ LCDM	P4_6	LCDENAB/ LCDM	P4_6	LCDENAB/ LCDM	P4_6	LCDENAB/ LCDM
LCD_FP	P4_5	LCDFP	P4_5	LCDFP	P4_5	LCDFP
LCD_DCLK	P4_7	LCDDCLK	P4_7	LCDDCLK	P4_7	LCDDCLK
LCD_LE	P7_0	LCDLE	P7_0	LCDLE	P7_0	LCDLE
LCD_PWR	P7_7	CDPWR	P7_7	LCDPWR	P7_7	LCDPWR
GP_CLKIN	PF_4	LCDCLKIN	PF_4	LCDCLKIN	PF_4	LCDCLKIN

Table 39. LCD panel connections for STN dual panel mode

External pin	4-bit mono STN dual panel		8-bit mono STN dual panel		Color STN dual panel	
	LPC43xx pin used	LCD function	LPC43xx pin used	LCD function	LPC43xx pin used	LCD function
LCD_VD[23:16]	-	-	-	-	-	-
LCD_VD15	-	-	PB_4	LD[7]	PB_4	LD[7]
LCD_VD14	-	-	PB_5	LD[6]	PB_5	LD[6]
LCD_VD13	-	-	PB_6	LD[5]	PB_6	LD[5]
LCD_VD12	-	-	P8_3	LD[4]	P8_3	LD[4]
LCD_VD11	P4_9	LD[3]	P4_9	LD[3]	P4_9	LD[3]
LCD_VD10	P4_10	LD[2]	P4_10	LD[2]	P4_10	LD[2]
LCD_VD9	P4_8	LD[1]	P4_8	LD[1]	P4_8	LD[1]
LCD_VD8	P7_5	LD[0]	P7_5	LD[0]	P7_5	LD[0]
LCD_VD7	-	-		UD[7]	P8_4	UD[7]
LCD_VD6	-	-	P8_5	UD[6]	P8_5	UD[6]
LCD_VD5	-	-	P8_6	UD[5]	P8_6	UD[5]
LCD_VD4	-	-	P8_7	UD[4]	P8_7	UD[4]
LCD_VD3	P4_2	UD[3]	P4_2	UD[3]	P4_2	UD[3]



The glitch filter rejects pulses of typical 12 ns width.

Fig 46. Standard I/O pin configuration with analog input

13.6 Reset pin configuration

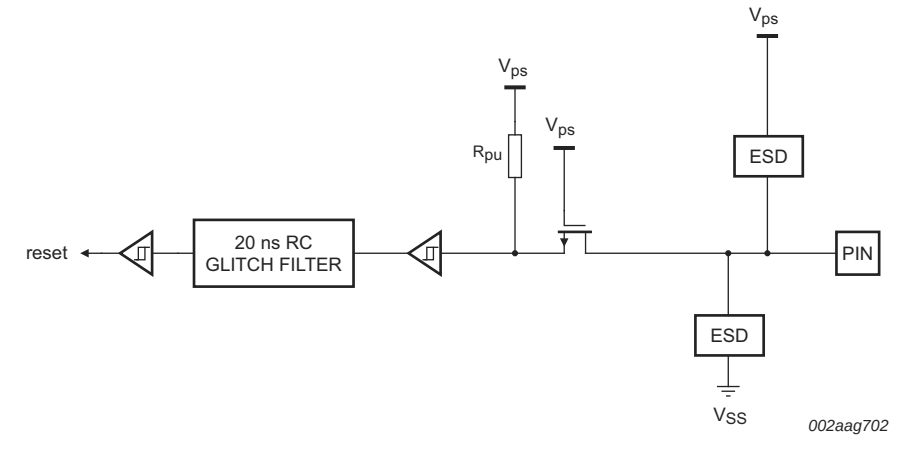
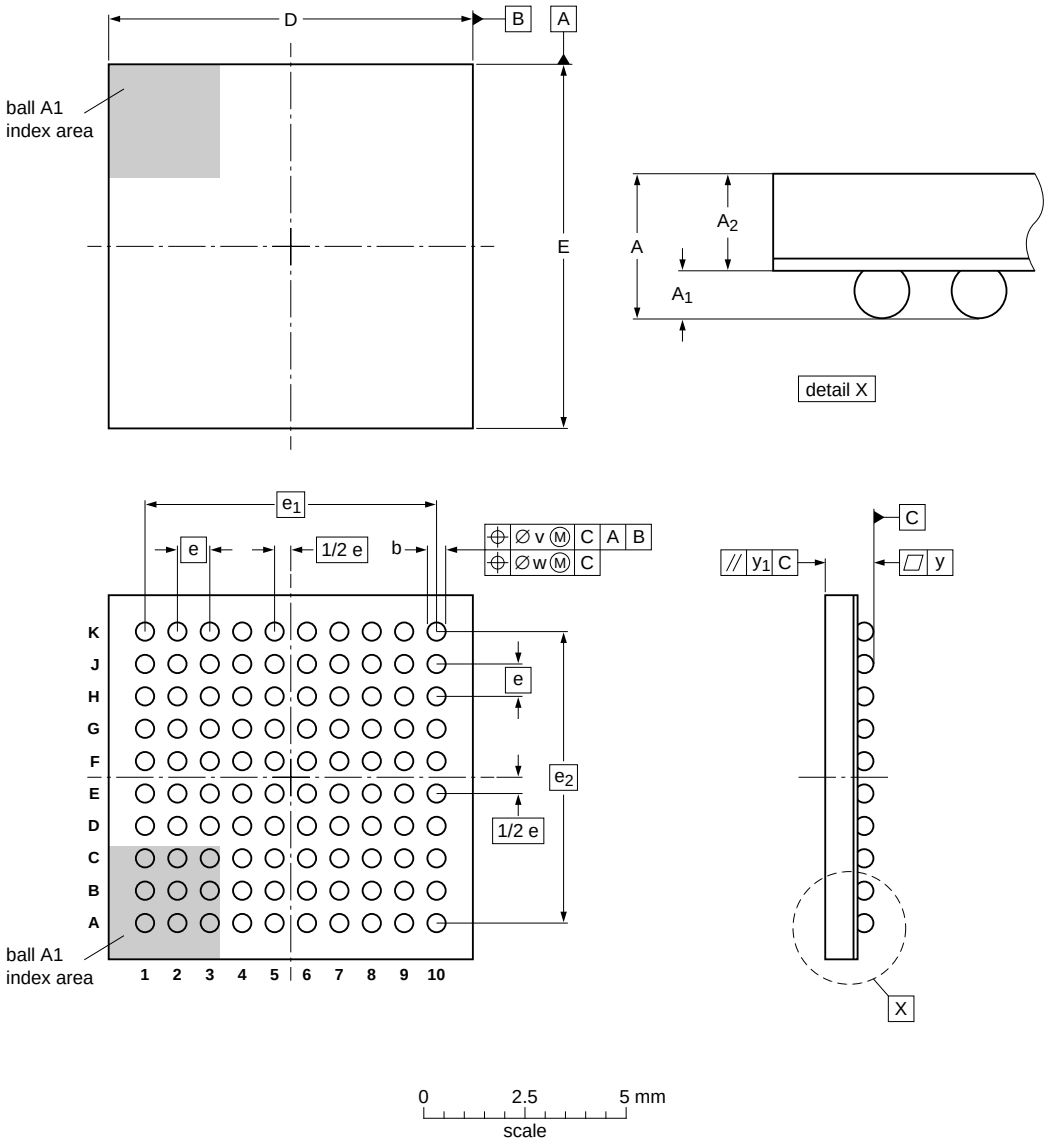


Fig 47. Reset pin configuration

13.7 Suggested USB interface solutions

The USB device can be connected to the USB as self-powered device (see Figure 48) or bus-powered device (see Figure 49).

TFBGA100: plastic thin fine-pitch ball grid array package; 100 balls; body 9 x 9 x 0.7 mm **SOT926-1**



DIMENSIONS (mm are the original dimensions)

UNIT	A max	A_1	A_2	b	D	E	e	e_1	e_2	v	w	y	y_1
mm	1.2	0.4 0.3	0.8 0.65	0.5 0.4	9.1 8.9	9.1 8.9	0.8	7.2	7.2	0.15	0.05	0.08	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT926-1	- - -	- - -	- - -			~~05-12-09~~ 05-12-22

Fig 53. Package outline of the TFBGA100 package

18. Revision history

Table 44. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
LPC4350_30_20_10 v.4.6	20160314	Product data sheet	-	LPC4350_30_20_10 v.4.5
Modifications:	• Updated Table 28 “Dynamic characteristics: Dynamic external memory interface”: Read cycle parameters $t_{h(D)}$ min value is 2.2 ns and max value is “-”.			
LPC4350_30_20_10 v.4.5	20151126	Product data sheet	-	LPC4350_30_20_10 v.4.4
Modifications:	• Fixed the revision number on the first page to v.4.5. In v.4.4 of the document, the revision number of the first page was v.4.3 while the document was at v.4.4. • Added a table note: The values in the table have been calculated with WAITTURN = 0x0 in STATICWAITTURN register. See Table 27 “Dynamic characteristics: Static asynchronous external memory interface”. • Changed footnote 12 in Table 3 “Pin description” with the text: VPP is internally connected to VDDIO for all packages with the exception of the LFBGA256 package. • Updated Figure 29 “I2S-bus timing (receive)”: for signal I2Sx_RX_WS changed second half of the signal from tsu(D) to th(D).			
LPC4350_30_20_10 v.4.4	20151117	Product data sheet	2015110031	LPC4350_30_20_10 v.4.3
Modifications:	• Added GPCLKIN section and table. See Section 11.6 “GPCLKIN” and Table 19 “Dynamic characteristic: GPCLKIN”. • Updated SSP slave and SSP master values in Table 24 “Dynamic characteristics: SSP pins in SPI mode”. Updated footnote 2 to: $T_{cy(clk)} \geq 12 \times T_{cy(PCLK)}$. – removed $t_{v(Q)}$, data output valid time in SPI mode, minimum value of 3 ´ (1/PCLK) from SSP slave mode. – added units to t_d, delay time, for SSP slave and master mode.			
LPC4350_30_20_10 v.4.3	20150430	Product data sheet		LPC4350_30_20_10 v.4.2
Modifications:	• Updated Section 1 “General description”. • Table note 2 corrected in Table 10. • Updated USART dynamic characteristics table. See Table 23. • Updated SD/MMC dynamic characteristics table. See Table 33. • Updated SPIFI dynamic characteristics table. See Table 35. • Added SSP slave timing data. See Table 24. • Updated USB dynamic characteristics table: USB0 and USB1 pins (full-speed). t_r Min 4 ns, Max 20 ns; t_f Min 4 ns, Max 20 ns; t_{FRFM} Min 90 %, Max 111.11 %. See Table 30: • Added band gap characteristics table. See Table 13. • Added motor control PWM instead of PWM to Table 2. • Added remark to Table 30.			
LPC4350_30_20_10 v.4.2	20140818	Product data sheet	201408013F01	LPC4350_30_20_10 v.4.1

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

19.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

I²C-bus — logo is a trademark of NXP B.V.

20. Contact information

For more information, please visit: **http://www.nxp.com**

For sales office addresses, please send an email to: **salesaddresses@nxp.com**

21. Contents

1 General description 1
2 Features and benefits 1
3 Applications 4
4 Ordering information 5
4.1 Ordering options 5
5 Block diagram 6
6 Pinning information 7
6.1 Pinning 7
6.2 Pin description 8
7 Functional description 61
7.1 Architectural overview 61
7.2 ARM Cortex-M4 processor 61
7.3 ARM Cortex-M0 co-processor 61
7.4 Interprocessor communication 61
7.5 AHB multilayer matrix 62
7.6 Nested Vectored Interrupt Controller (NVIC) . 62
7.6.1 Features 63
7.6.2 Interrupt sources 63
7.7 System Tick timer (SysTick) 63
7.8 Event router 63
7.9 Global Input Multiplexer Array (GIMA) 63
7.9.1 Features 64
7.10 On-chip static RAM 64
7.11 In-System Programming (ISP) 64
7.12 Boot ROM 64
7.13 Memory mapping 65
7.14 One-Time Programmable (OTP) memory . . . 68
7.15 General-Purpose I/O (GPIO) 68
7.15.1 Features 68
7.16 Configurable digital peripherals 68
7.16.1 State Configurable Timer (SCTimer/PWM) subsystem 68
7.16.1.1 Features 69
7.16.2 Serial GPIO (SGPIO) 69
7.16.2.1 Features 69
7.17 AHB peripherals 70
7.17.1 General-Purpose DMA (GPDMA) 70
7.17.1.1 Features 70
7.17.2 SPI Flash Interface (SPIFI) 70
7.17.2.1 Features 71
7.17.3 SD/MMC card interface 71
7.17.4 External Memory Controller (EMC) 71
7.17.4.1 Features 71
7.17.5 High-speed USB Host/Device/OTG interface (USB0) 72
7.17.5.1 Features 72
7.17.6 High-speed USB Host/Device interface with ULPI (USB1) 72
7.17.6.1 Features 72
7.17.7 LCD controller 73
7.17.7.1 Features 73
7.17.8 Ethernet 74
7.17.8.1 Features 74
7.18 Digital serial peripherals 74
7.18.1 UART1 74
7.18.1.1 Features 74
7.18.2 USART0/2/3 75
7.18.2.1 Features 75
7.18.3 SPI serial I/O controller 75
7.18.3.1 Features 75
7.18.4 SSP serial I/O controller 75
7.18.4.1 Features 76
7.18.5 I^2C-bus interface 76
7.18.5.1 Features 76
7.18.6 I^2S interface 76
7.18.6.1 Features 77
7.18.7 C_CAN 77
7.18.7.1 Features 77
7.19 Counter/timers and motor control 78
7.19.1 General purpose 32-bit timers/external event counters 78
7.19.1.1 Features 78
7.19.2 Motor control PWM 78
7.19.3 Quadrature Encoder Interface (QEI) 78
7.19.3.1 Features 78
7.19.4 Repetitive Interrupt (RI) timer 79
7.19.4.1 Features 79
7.19.5 Windowed WatchDog Timer (WWDT) 79
7.19.5.1 Features 79
7.20 Analog peripherals 80
7.20.1 Analog-to-Digital Converter (ADC0/. . . . . 1) 80
7.20.1.1 Features 80
7.20.2 Digital-to-Analog Converter (DAC) 80
7.20.2.1 Features 80
7.21 Peripherals in the RTC power domain 80
7.21.1 RTC 80
7.21.1.1 Features 80
7.21.2 Alarm timer 81
7.22 System control 81
7.22.1 Configuration registers (CREG) 81
7.22.2 System Control Unit (SCU) 81
7.22.3 Clock Generation Unit (CGU) 81
7.22.4 Internal RC oscillator (IRC) 82
7.22.5 PLL0USB (for USB0) 82

continued >>